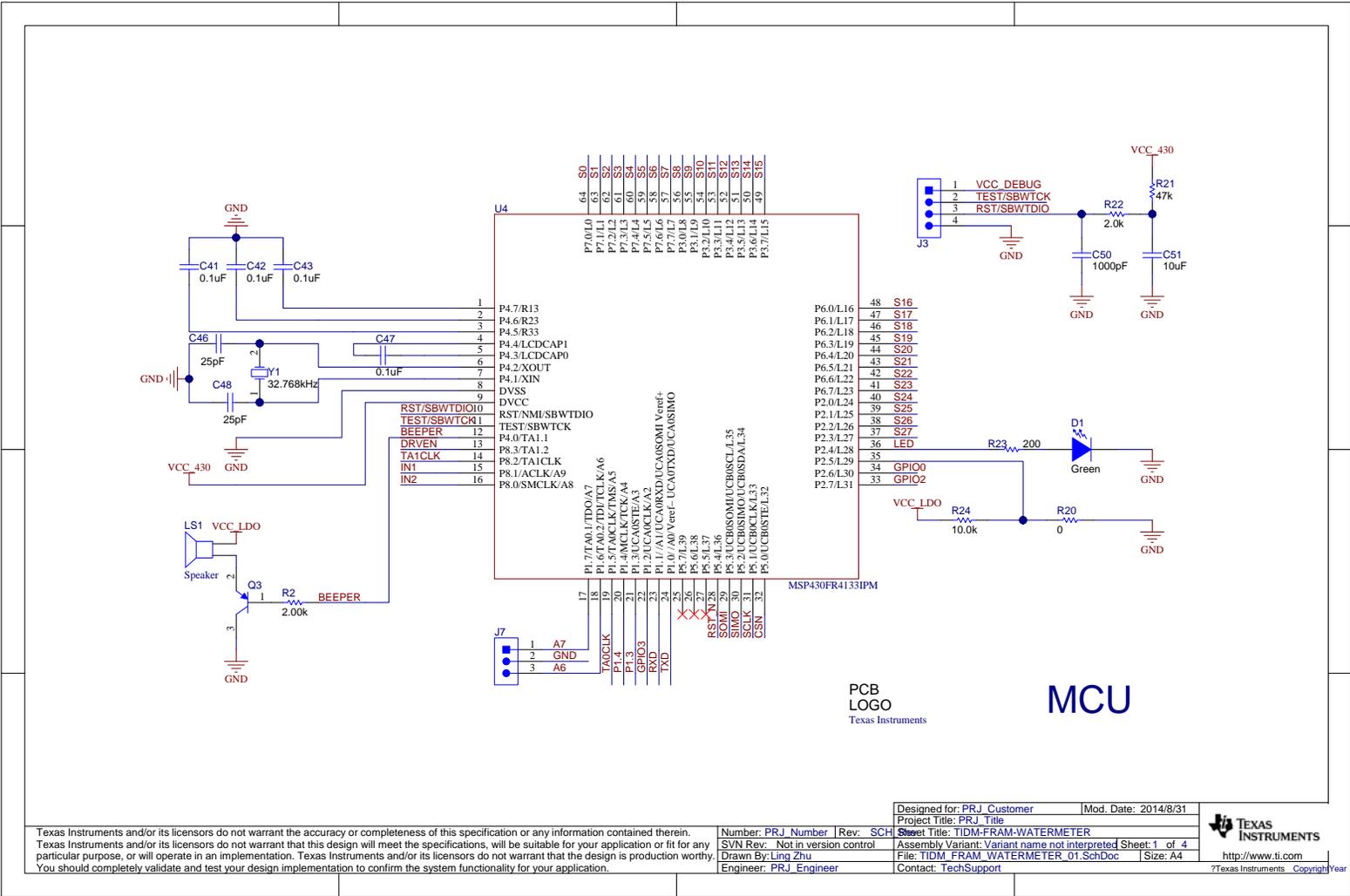
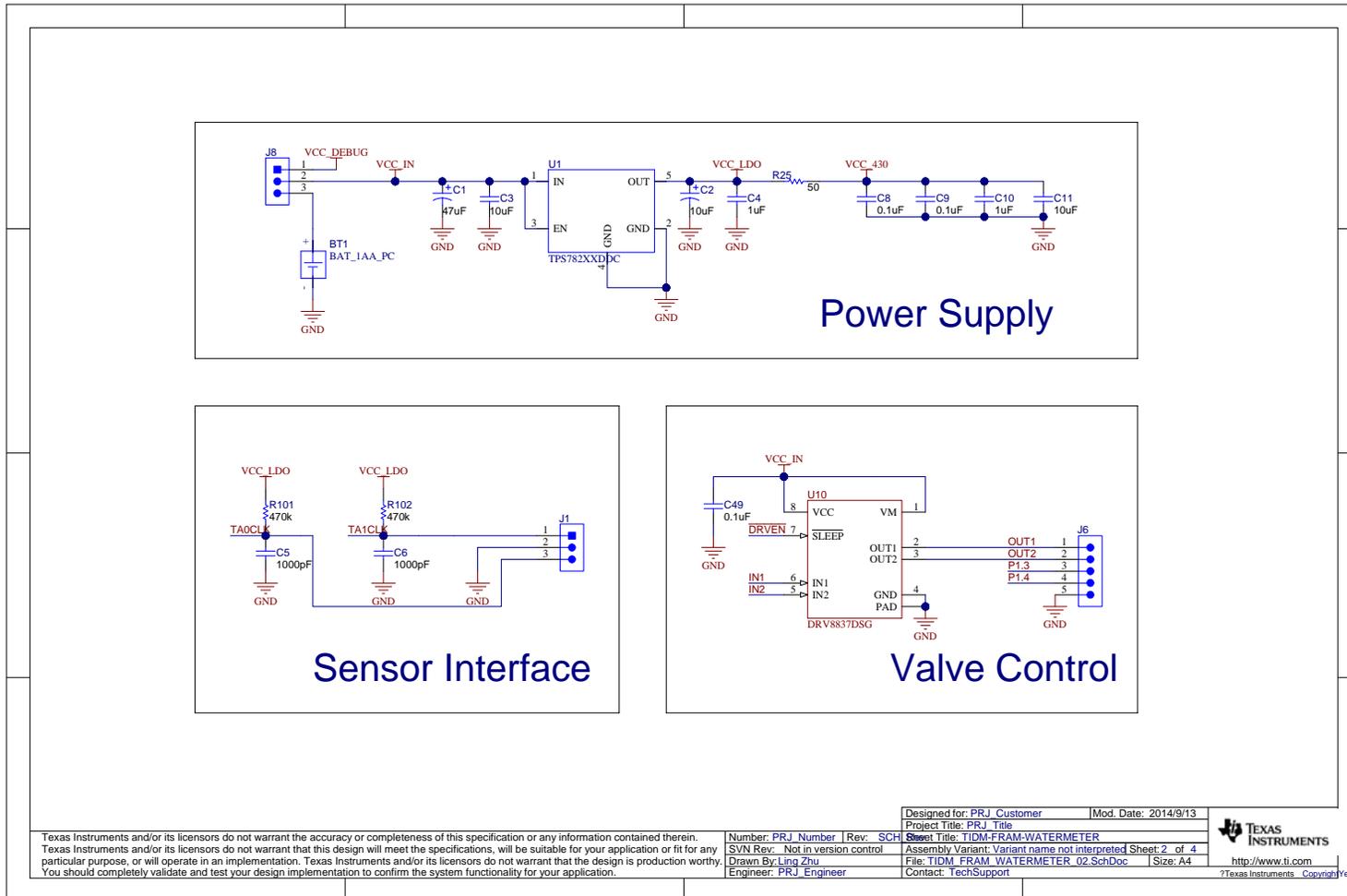


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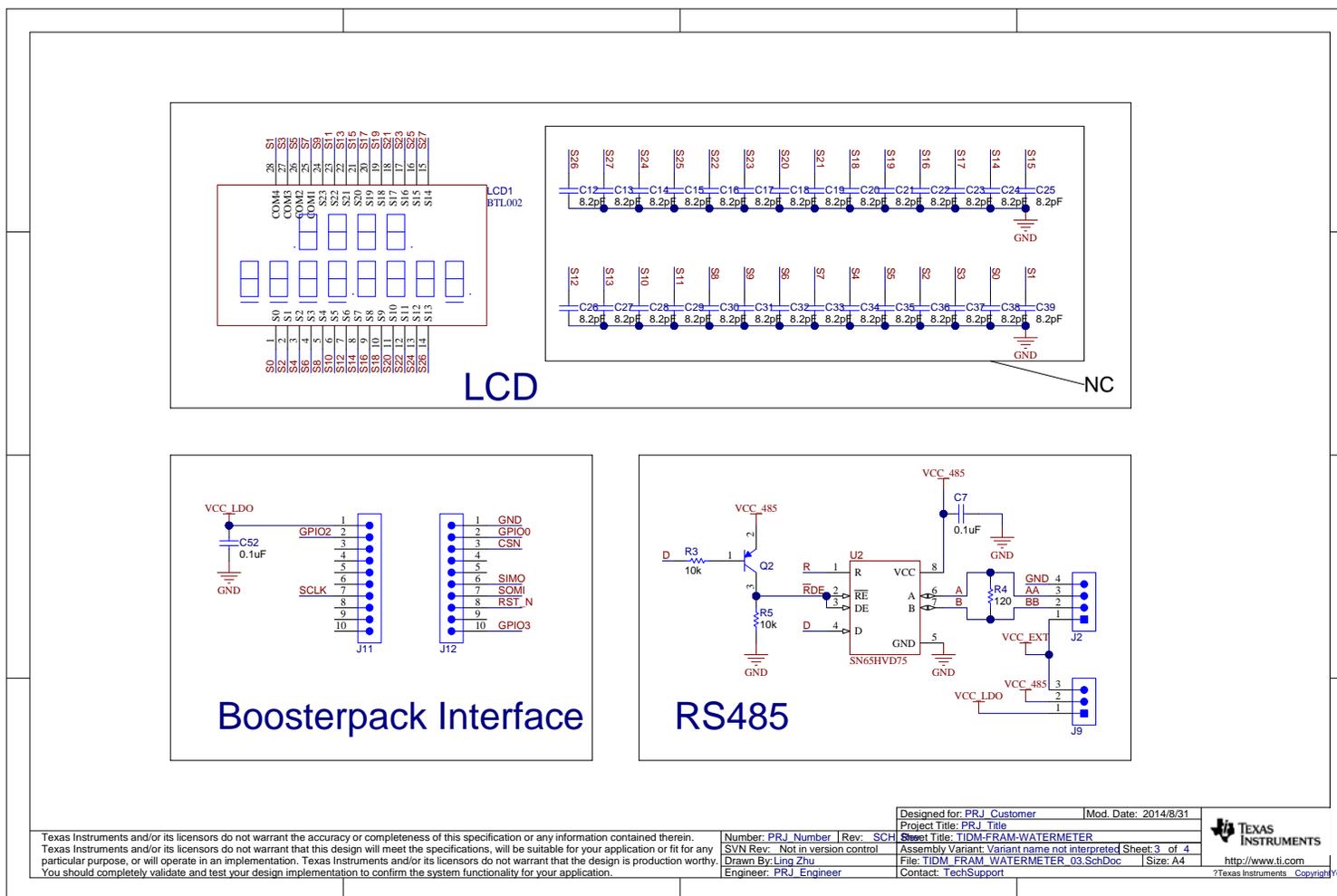


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Project Title: PRJ Title	Sheet Title: TIDM-FRAM-WATERMETER
SVN Rev.: Not in version control	Assembly Variant: Variant name not interpreted
Drawn By: Ling Zhu	File: TIDM_FRAM_WATERMETER_02.SchDoc
Engineer: PRJ_Engineer	Contact: TechSupport

Sheet: 2 of 4
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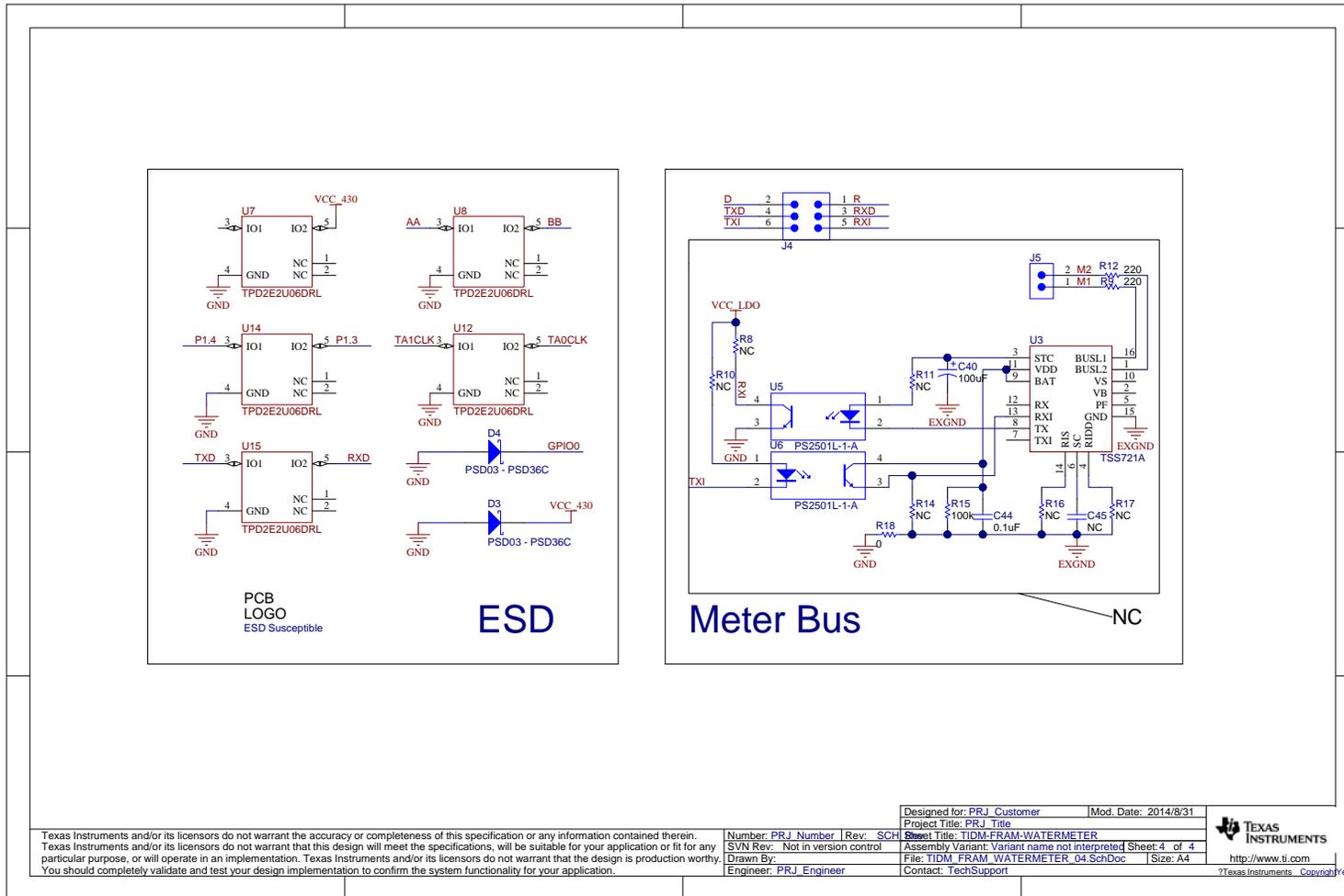


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SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted	Sheet: 3 of 4
Drawn By: Ling Zhu	File: TIDM_FRAM_WATERMETER_03.SchDoc	Size: A4
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 Project Title: PRJ Title
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